'LS673

- 16-Bit Serial-In, Serial-Out Shift Register with 16-Bit Parallel-Out Storage Register
- Performs Serial-to-Parallel Conversion

'LS674

- 16-Bit Parallel-In, Serial-Out Shift Register
- Performs Parallel-to-Serial Conversion

description

SN54LS673, SN74LS673

The 'LS673 is a 16-bit shift register and a 16-bit storage register in a single 24-pin package. A three-state input/output (SER/Q15) port to the shift register allows serial entry and/or reading of data. The storage register is connected in a parallel data loop with the shift register and may be asynchronously cleared by taking the storeclear input low. The storage register may be parallel loaded with shift-register data to provide shift-register status via the parallel outputs. The shift register can be parallel loaded with the storage-register data upon command.

A high logic level at the chip-level (\overline{CS}) input disables both the shift-register clock and the storage register clock and places SER/Q15 in the high-impedance state. The store-clear function is not disabled by the chip select.

Caution must be exercised to prevent false clocking of either the shift register or the storage register via the chip-select input. The shift clock should be low during the low-to-high transition of chip select and the store clock should be low during the high-to-low transition of chip select.

SN54LS674, SN74LS674

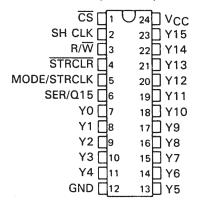
The 'LS674 is a 16-bit parallel-in, serial-out shift register. A three-state input/output (SER/Q15) port provides access for entering a serial data or reading the shift-register word in a recirculating loop.

The device has four basic modes of operation:

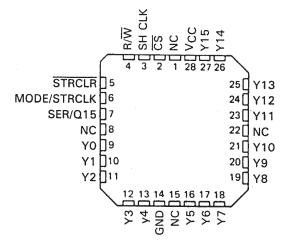
- 1) Hold (do nothing)
- 2) Write (serially via input/output)
- 3) Read (serially)
- 4) Load (parallel via data inputs)

Low-to-high-level changes at the chip select input should be made only when the clock input is low to prevent false clocking.

SN54LS673 . . . J OR W PACKAGE SN74LS673 . . . DW OR N PACKAGE (TOP VIEW)



SN54LS673 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection

SN54LS673, SN54LS674, SN74LS673, SN74LS674 16-BIT SHIFT REGISTERS

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SN54LS674 . . . J OR W PACKAGE SN74LS674 . . . DW OR N PACKAGE (TOP VIEW)

CS [1 U24] VCC CLK 2 23 P15 **R/W** □3 22 P14 NC ∏4 21 P13 20 P12 MODE ∏5 SER/Q15 ∏6 19 P11 P0 🛮 7 18 P10 17 P9 P2 9 16 P8 P3 []10 15 P7

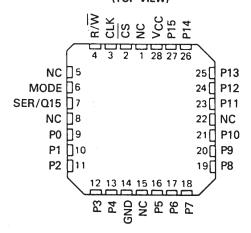
14 P6

13 P5

P4 ∐11

GND ☐12

SN54LS674 . . . FK PACKAGE (TOP VIEW)



'LS673 FUNCTION TABLE

	INPUTS MODE/						SHIFT REGIS	STER FUNCTIONS WRITE INTO	PARALLEL	STOF REGI	STER
CS	R/W	SH CLK	STRCLR	STRCLK	Q15	SHIFT	SERIAL OUTPUT	SERIAL INPUT	LOAD	FUNC	LOAD
Н	Х	X	Х	Х	Z	NO	NO	NO	NO		NO
X	Х	Х	L	Х						YES	
L	L	Į.	Х	Х	Z	YES	NO	YES	NO		
L	Н	х	Х	Х	Q15		YES	NO			NO
L	Н	1	Х	L	Q14n	YES	YES	NO	NO		NO
L	Н	Ţ	L	Н	L	NO	YES		YES	YES	NO
L	Н	ļ	Н	Н	Y15n	NO	YES		YES	NO	NO
L	L	Х	H	1	Z		NO		NO	NO	YES

'LS674 FUNCTION TABLE

		NPUTS		SER/	
cs	R/W	MODE	CLK	Q15	OPERATION
Н	X	X	х	Z	Do nothing
L	L	X	1	z	Shift and write (serial load)
L	н	L	Į.	Q14n	Shift and read
L	Н	Н	1	P15	Parallel load

H = high level (steady state)

L = low level (steady state)

1 = transition from low to high level

 \downarrow = transition from high to low level

X = irrelevant (any input including transitions)

Z = high impedance, input mode

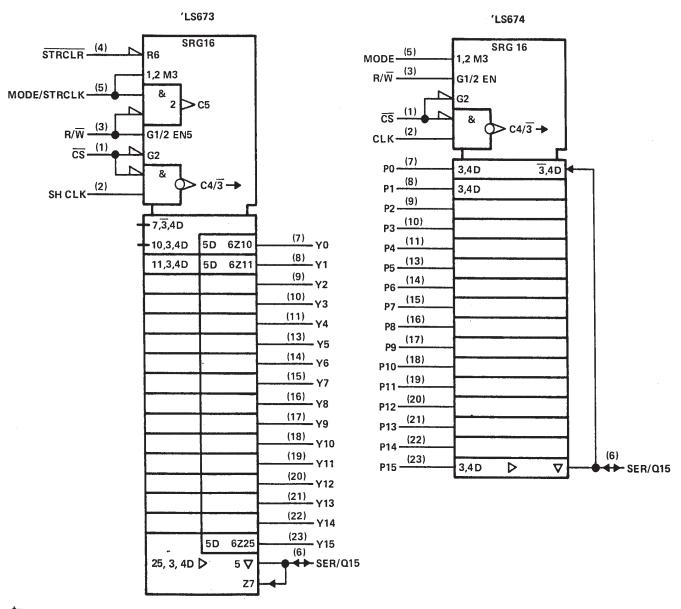
Q14n = content of 14th bit of the shift register before the most recent \$\foat\$ transition of the clock.

Q15 = present content of 15th bit of the shift register

Y15n = content of the 15th bit of the storage register before the most recent \$\psi\$ transition of the clock.

P15 = level of input P15

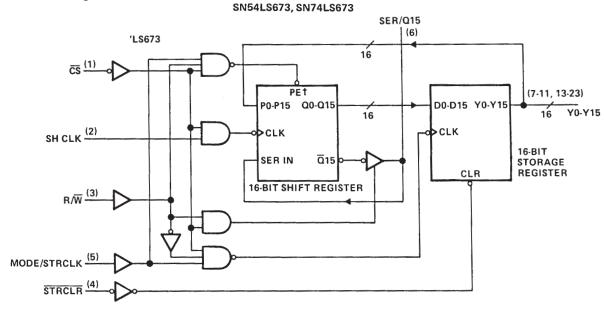
logic symbols†



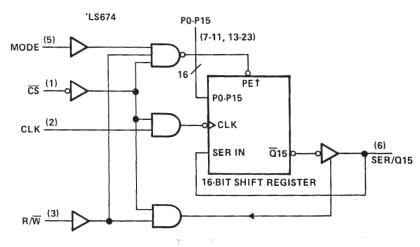
[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, N, and W packages.

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functional block diagrams

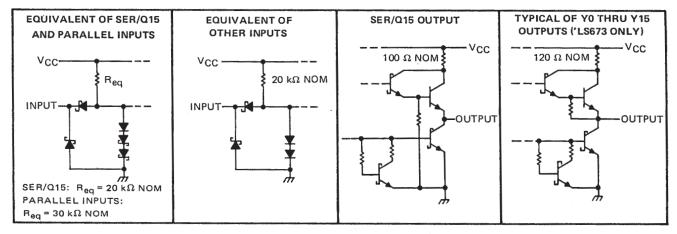


SN54LS674, SN74LS674



[†]When PE is active, data is synchronously parallel loaded into the shift registers from the 16 P inputs and no shifting takes place. Pin numbers shown are for DW, J, N, and W packages.

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	7 V
Input voltage: SER/Q15!	5.5 V
All others	7 V
Off-state output voltage!	5.5 V
Operating free-air temperature range: SN54LS673, SN54LS674	
`SN74LS673, SN74LS674 0°C to	70°C
Storage temperature range	50°C

NOTE 1. Voltage values are with respect to network ground terminal.

recommended operating conditions

					SN54LS	•	5	SN74LS'			
				MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage			4.5	5	5.5	4.75	5	5.25	V	
lau	High-level output current	SER/Q15				- 1			-2.6	mA	
ЮН	riigii-level output culterit	Y0 thru Y15				-0.4			-0.4	'''	
loi	Low-level output current	SER/Q15				12			24	mA	
lOL	Low-level output current	Y0 thru Y15				4			8] ""	
fclock	Clock frequency			0		20	0		20	MHz	
tw(clock)	Width of clock input pulse			20			20			ns	
^t w(clear)	Width of clear input pulse			20			20			ns	
		SER/Q15	20			20					
		P0 thru P15	20			20					
t	Setup time	Mode		35			35			ns	
t _{su}	Setup time	R/W, CS		35			35] '''	
		SH CLK ↓ to M See Note 2	ode/STR CLK ↑	25			25				
		SER/Q15		0			0				
t _h Hold time	Uald sima	P0 thru P15	'LS673	0			0			ns	
	FOUNTUFIS	'LS674	5.0			5.0] ""		
		Mode		0			. 0			1	
T _A	Operating free-air temperat	ure		- 55		125	0		70	°C	

NOTE 2: This setup time ensures the storage register will see stable data from the shift register.



SN54LS673, SN54LS674, SN74LS673, SN74LS674 16-BIT SHIFT REGISTERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONI	DITIONST		SN54LS	3'	SN74LS'			LINIT
	FANAMETER		TEST CON	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIH	High-level input voltage			2			2			٧	
VIL	Low-level input voltage						0.7			0.8	V
٧١K	Input clamp voltage		V _{CC} = MIN,	I _I = -18 mA			-1.5			-1.5	V
Vон	High-level output voltage	SER/Q15	VCC = MIN,	V _{1H} = 2 V,	2.4	3.2		2.4	3.1		V
VOH	riigii-ievei odtput voitage	Y0 thru Y15¶	V _{IL} = V _{IL} max,	IOH = MAX	2.5	3.4		2.7	3.4		\ \
		SER/Q15	V _{CC} = MIN,	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	
VOL	Low-level output voltage	3EN/Q15		I _{OL} = 24 mA					0.35	0.5	1 .,
VOL.	Low-level odtput voltage	Y0 thru Y15¶	V _{IH} = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	\ \
		10 0110 1 15 1	VIL = VILmax	I _{OL} = 8 mA					0.35	0.5	1
lown	Off-state output current,	SER/Q15	VCC = MAX,	V _{IH} = 2 V,			40			40	
lozh	high-level voltage applied	3EN/Q15	VIL = VILmax,	$V_0 = 2.7 V$			40			40	μΑ
lozL	Off-state output current,	050/045	V _{CC} = MAX,	V _{IH} = 2 V,							
102L	low-level voltage applied	SER/Q15	VIL = VILmax,	$V_0 = 0.4 V$			- 0.4			- 0.4	mA
l ₁	Input current at maximum	SER/Q15	\/ MAY	V _I = 5.5 V			0.1			0.1	
1	input voltage	Others	V _{CC} = MAX	V _I = 7 V			0.1			0.1	mA
Ιн	High-level input current	SER/Q15	V _{CC} = MAX,	V ₁ = 2.7 V			40			40	
'111		Others	VCC - WAX,	V - 2.7 V			20			20	μА
IL	Low-level input current		VCC = MAX,	V ₁ = 0.4 V			-0.4			-0.4	mA
los	Short-circuit output current§	SER/Q15	V _{CC} = MAX		-30		-130	-30		-130	
-05	onort-circuit output currents	Y0 thru Y15¶	VCC - WAX		-20		-100	-20		-100	mA
Icc	Supply current	'LS673	V _{CC} = MAX			50	80		52	80	- A
100	ouppiy current	'LS674	ACC - MINY			25	40		25	40	mA

[†]For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$, see note 2

PARAMETER	'L	S673	'LS	674	TECT CONDITIONS	MIN	TYP	MAN	UNIT
PANAMETER	FROM	то	FROM	то	TEST CONDITIONS		111	MAX	UNII
f _{max}	SH CLK	SER/Q15	CLK	SER/Q15	$R_L = 667 \Omega, C_L = 45 pF$	20	28		MHz
tPHL t	STRCLR	Y0 thru Y15					25	40	
^t PLH	MODE/	Y0 thru Y15			$R_L = 2 k\Omega$, $C_L = 15 pF$		28	45	ns
^t PHL	STRCLK	10 0110 115					30	45	
^t PLH	SH CLK	SER/Q15	CLK	SER/Q15	R _L = 667 Ω, C _L = 45 pF		21	33	ns
^t PHL	311 OZK	3E11/Q13	CER	3211/013	ME - 007 22, CE - 45 pi		26	40	1115
^t PZH	CS, R/W	SER/Q15	CS, R/₩	SER/Q15	R _L = 667 Ω, C _L = 45 pF		30	45	ns
^t PZL	00,11,77	5211,413	00,11,11	3211/013	11 = 007 12, CL = 43 pi		30	45	113
^t PHZ	CS, R/W	SER/Q15	CS, R/W	SER/Q15	R _L = 667 Ω, C _L = 5 pF		25	40	ne
tPLZ	00,11,11	0211/013	03,11/11	3011/013	т007 12, С5 рг		25	40	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



 $[\]ddagger$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

^{¶&#}x27;LS673 only.





9-Mar-2021

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-88602013A	ACTIVE	LCCC	FK	28	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88602013A SNJ54LS 673FK	Sample
5962-8860201JA	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201JA SNJ54LS673J	Sample
5962-8860201JA	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201JA SNJ54LS673J	Sample
5962-8860201LA	ACTIVE	CDIP	JT	24	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8860201LA SNJ54LS673JT	Sample
5962-8860201LA	ACTIVE	CDIP	JT	24	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8860201LA SNJ54LS673JT	Sample
5962-88607013A	ACTIVE	LCCC	FK	28	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88607013A SNJ54LS 674FK	Sample
5962-88607013A	ACTIVE	LCCC	FK	28	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88607013A SNJ54LS 674FK	Sample
5962-8860701JA	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	5962-8860701JA SNJ54LS674J	Sample
5962-8860701JA	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	5962-8860701JA SNJ54LS674J	Sample
SN54LS673J	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	SN54LS673J	Sample
SN54LS673J	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	SN54LS673J	Sample
SN54LS674J	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	SN54LS674J	Sample
SN54LS674J	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	SN54LS674J	Sample
SN74LS673DW	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS673	Sample



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Sample
SN74LS673DW	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS673	Sample
SN74LS674DW	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS674	Sample
SN74LS674DW	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS674	Sample
SN74LS674DWG4	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS674	Sample
SN74LS674DWG4	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS674	Sample
SNJ54LS673FK	ACTIVE	LCCC	FK	28	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88602013A SNJ54LS 673FK	Sample
SNJ54LS673FK	ACTIVE	LCCC	FK	28	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88602013A SNJ54LS 673FK	Sampl
SNJ54LS673J	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201JA SNJ54LS673J	Sampl
SNJ54LS673J	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201JA SNJ54LS673J	Sampl
SNJ54LS673JT	ACTIVE	CDIP	JT	24	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8860201LA SNJ54LS673JT	Sampl
SNJ54LS673JT	ACTIVE	CDIP	JT	24	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8860201LA SNJ54LS673JT	Sampl
SNJ54LS674FK	ACTIVE	LCCC	FK	28	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88607013A SNJ54LS 674FK	Sampl
SNJ54LS674FK	ACTIVE	LCCC	FK	28	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88607013A SNJ54LS 674FK	Sampl
SNJ54LS674J	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	5962-8860701JA SNJ54LS674J	Sampl
SNJ54LS674J	ACTIVE	CDIP	J	24	1	Non-RoHS & Non-Green	Call TI	N / A for Pkg Type	-55 to 125	5962-8860701JA SNJ54LS674J	Sampl

PACKAGE OPTION ADDENDUM



9-Mar-2021

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS673, SN54LS674, SN74LS673, SN74LS674:

Catalog: SN74LS673, SN74LS674

Military: SN54LS673, SN54LS674

NOTE: Qualified Version Definitions:





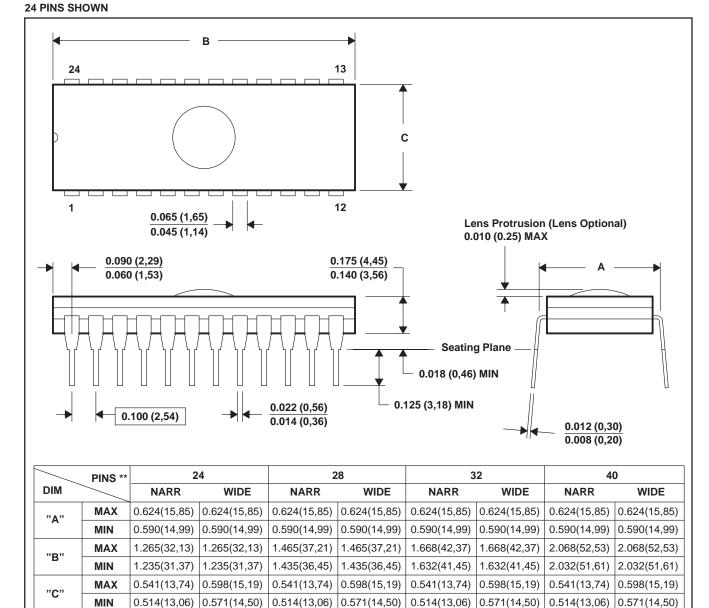
9-Mar-2021

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

4040084/C 10/97

J (R-GDIP-T**)

CERAMIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Window (lens) added to this group of packages (24-, 28-, 32-, 40-pin).
- D. This package can be hermetically sealed with a ceramic lid using glass frit.
- E. Index point is provided on cap for terminal identification.



JT (R-GDIP-T**)

24 LEADS SHOWN

CERAMIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



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